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Title: Micro-X-ray Fluorescence (MXRF) Direct Solids

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# Micro-X-ray Fluorescence (MXRF) Direct Solids

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## **Outline**



Description of our XRF capabilities

Micro-XRF (MXRF) introduction

MXRF BSAP examples

Summary

## **XRF Capabilities**



Wavelength dispersive XRF (WDXRF)

Polarized energy dispersive XRF (Polarized EDXRF)

Handheld XRF

Micro-focused X-ray beam XRF (MXRF)

## Wavelength Dispersive XRF (WDXRF)



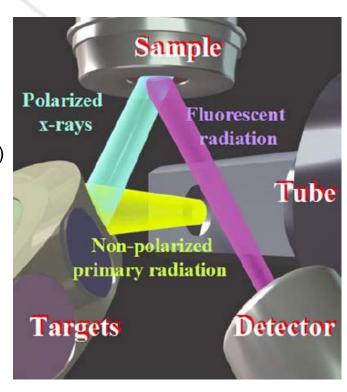
- High power 4000 Watt Rh x-ray tube
- Elemental Range: Boron & Fluorine Americium
- Advantages
  - Automated: 150 samples can be batched
  - Best sensitivity and reproducibility
  - Best for low Z elements
  - Best for high rad samples No detector saturation
- Limitations
  - Sequential spectrometer
    - Scan one element at a time
    - Slow for analysis of large set of elements
  - High power X-rays can damage fragile samples
  - Most expensive XRF instrument



## Polarized Energy Dispersive XRF (Polarized EDXRF)



- 100 kV X-ray tube
  - Excellent sensitivity for medium & high Z elements
- Elemental range: Sodium to Curium
- 15 secondary target choices
  - Choose target to optimize elemental detection limits (LLDs)
  - Reduced spectral background Even better LLDs
  - Minimal sample prep Ratio to secondary target X-ray scatter instead of adding internal standard
- No sample damage
  - Secondary target X-rays do not heat the sample
  - Long count times possible Ultimate LLDs
- Very high rad samples can saturate the detector
- EDXRF energy resolution not as high as WDXRF
- EDXRF low Z elemental sensitivity worse than WDXRF



## Handheld XRF



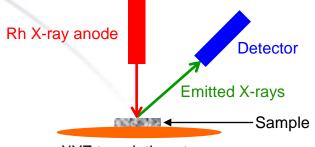
- Portable Take instrument to the sample
- Hold to surface and pull trigger
- Elemental range: Sodium to Americium
- Metal alloy identification
  - Glove box steel grade ID for QA documentation
  - Sample containers alloy ID
- Qualitative analysis of any large object
- Pu and TRU quantification possible with method development



## Micro-XRF (MXRF)

- EDAX Orbis instrument
- 30 μm diameter irradiated spot
- 1 & 2 mm spot sizes Larger samples
- Move sample on stage to image surface elemental distributions
- Elemental range: Sodium to curium
- Image up to 10 cm x 10 cm areas
- X-ray source filters
  - Improves elemental detection limits





XYZ translation stage

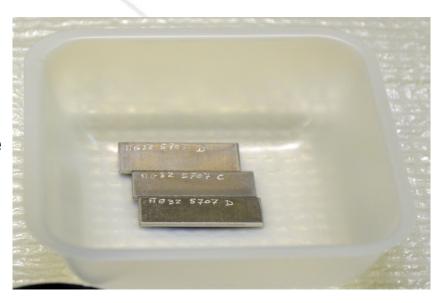




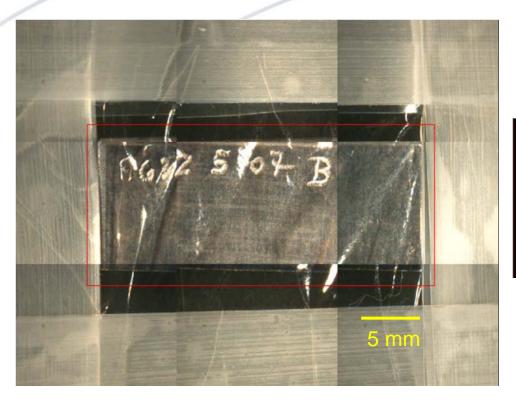


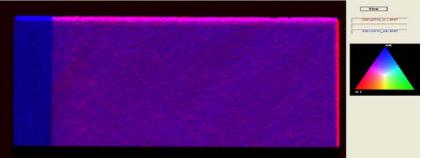


- HEU/aluminum alloy submitted for comprehensive chemical analysis
- Originally understood the material to be fairly homogeneous
- NDA characterization by MXRF
  - Plate compositions <u>NOT</u> uniform
  - MXRF used to guide where to extract material for further characterization
  - 3D elemental structure HEU fuel plates with Al cladding; <u>NOT</u> homogenous









MXRF U & Al image overlay

Blue = Aluminum

Red = Uranium L

Pink = Al & U overlap

- No U on left edge First evidence of aluminum cladding surrounding U layer
- Next mounted on cut edge to analyze material inside the plate

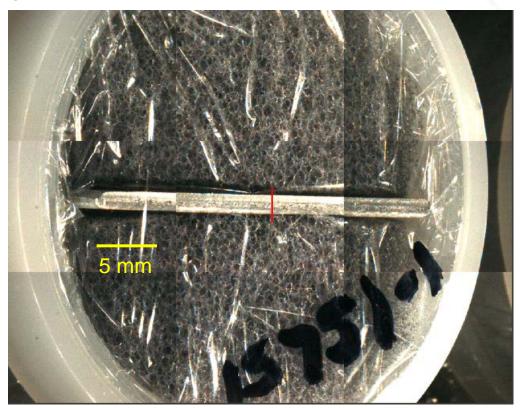




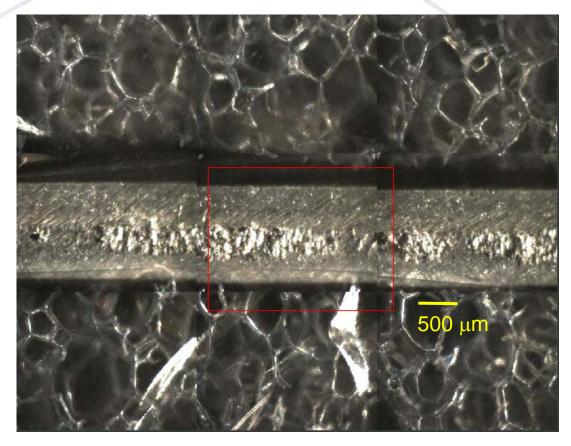


## HEU/Al plate mounted with cut edge facing up

(Edge cut with sheet metal shear prior to receipt of sample)



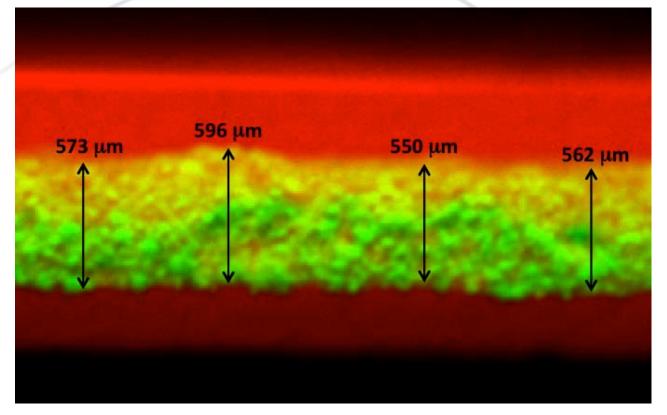




Used MXRF to image red boxed area of plate edge



Aluminum Uranium



- Direct confirmation of HEU layer between Al cladding
- Measured U layer thickness
- HEU layer spectral analysis → U & Al alloy





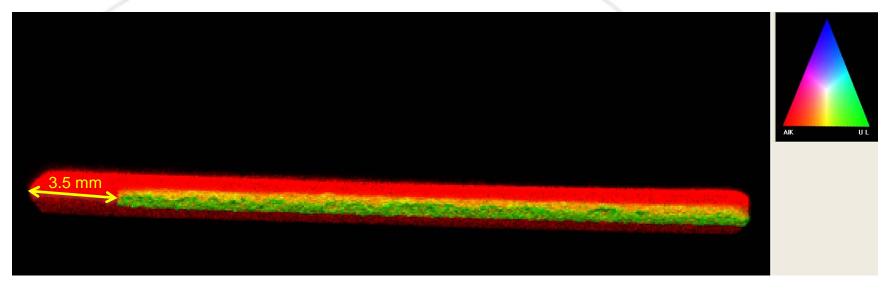


Image of entire cut edge - Aluminum and uranium overlay

Red = Aluminum Green = Uranium



### Standard-less quantification

- Approximate concentrations only (high fidelity quant requires standards)
- Analyzed areas of HEU & Al layers exposed on cut edge using microfocused X-ray beam
- HEU layer only ~9% Uranium; majority aluminum
- Aluminum layer almost all Al; a few impurities present

### **Uranium-containing Layer**

Element	Approx Wt%
Aluminum	90.7
Uranium	9.1
Miscell impurities	0.2

### **Aluminum Layer**

Element	Approx Wt%
Aluminum	98.7
Calcium	0.6
Iron	0.5
Miscell impurities	0.2



## MXRF - Electrorefined (ER) Plutonium Metal



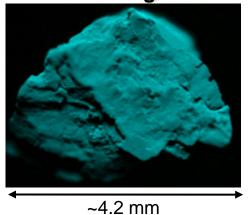
- ER Pu metal cuts always extracted from parent for chemical analyses (eg. trace elements by ICP)
- If parent not homogenous, will affect reported chemistry results

 MXRF was examined as an NDA method to detect any parent metal elemental heterogeneity prior to DA

## **MXRF - ER Plutonium Metal**

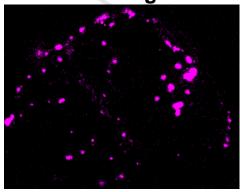


### Pu image

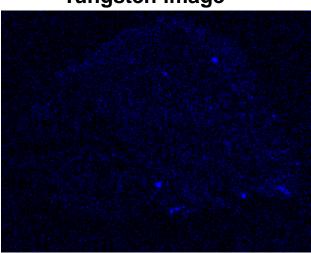


350 mg Pu metal chunk

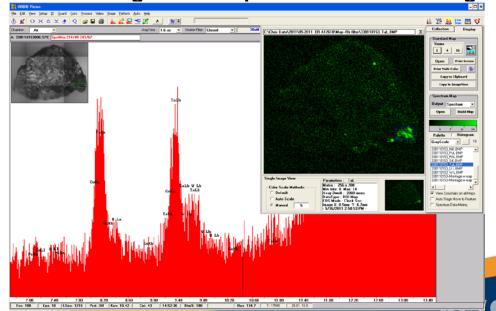
#### Iron image



**Tungsten image** 



### Tantalum image & XRF spectrum from lower right

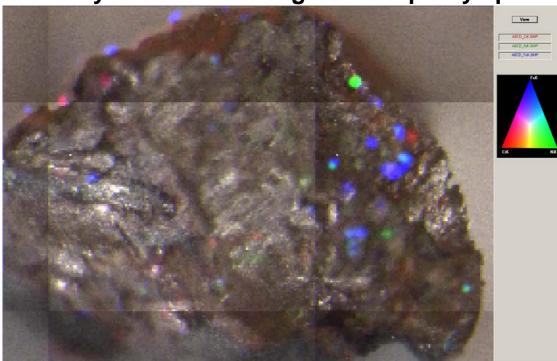


## **MXRF - ER Plutonium Metal**



- Fe, Ni, Cr spots detected
  - Pu surface oxide removed with steel wire brush
  - A few spots have steel signatures (purple & cyan)
  - Some steel residue from wire brush may be present
  - But other spots are due to a single element (eg. nickel green spot)
  - Some spots indicate sample heterogeneity (ie. pure blue, green, or red)
- If heterogeneity detected by MXRF, avoid T&E repeating ICP prep and analysis

### Overlay of Pu metal image with impurity spots



Fe Ni Cr

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## Cast Pu Metal MXRF of ~9 mm x ~6 mm area

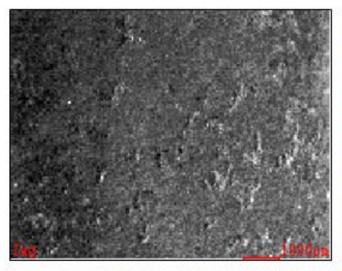


Fe

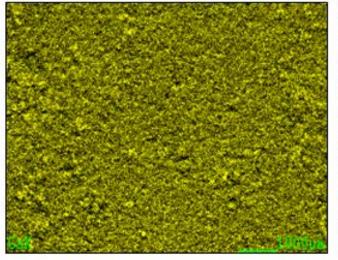
Relative

Intensity

Visible Image



Ga Relative Intensity



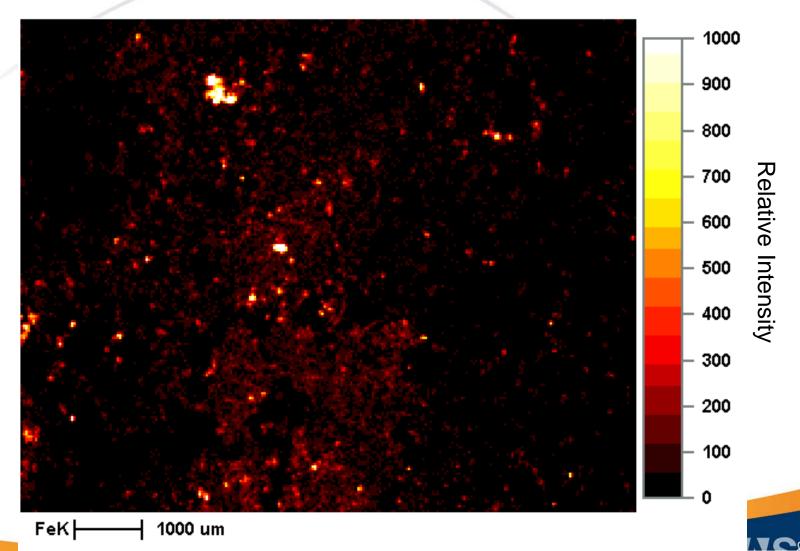


Pu Relative Intensity



## Cast Pu Metal – IRON MXRF MAP



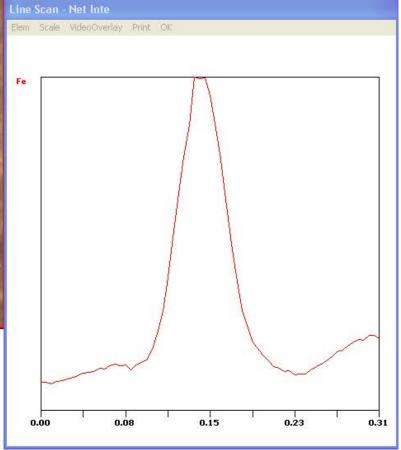


## **Cast Pu Metal Smaller Area & Iron Line Scan**





**310** μm Line scan in green



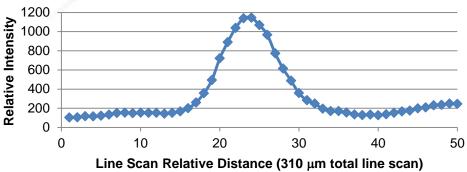
Distance (mm)



## Cast Pu Metal **MXRF Line Scan Relative Intensities**\*

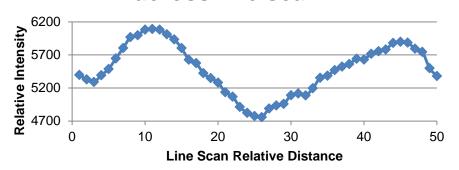


### **IRON** - Relative intensity across line scan

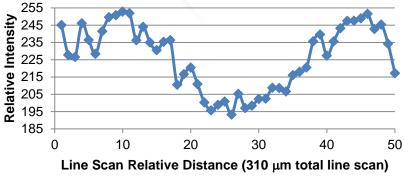


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### **PLUTONIUM** - Relative intensity across line scan



### **GALLIUM** - Relative intensity across line scan





## **Summary**



- MXRF complements other imaging techniques such as SEM-EDS.
- MXRF method of choice for:
  - Large area analyses (up to 100 cm<sup>2</sup> areas)
  - True NDA No damage from X-ray beam
  - Medium and high atomic number elemental analyses
  - Non-conducting materials (eg. plastics, HEPA filters, etc.)
  - Samples incompatible with vacuum (eg. liquids, moist samples)
- Presented several MXRF BSAP-related applications
- Other examples of XRF BSAP-related applications
  - Signatures from test debris
  - Gallium and uranium quantification in Pu metals and oxides
  - Alloy identification of NM forensics sample containers
  - Approximate quantification of major & minor elements in Pu oxides

